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Examiner: David Graybill

VERSIONS WITH MARKING TO SHOW CHANGES MADE

In the Claims

1. A sublamination material, comprising:
a conductive single layer reference plane having a top surface and a bottom surface;
a conductive first signal layer coupled to the top surface with a cured core material, the first signal layer having an exposed surface opposite a surface coupled to the reference plane;
a conductive second signal layer coupled to the bottom surface with a cured bond-ply material, the second signal layer having an exposed surface opposite a surface coupled to the reference plane; and
at least one of a blind via or a micro via; wherein the reference plane, first signal layer, and second signal layer are three separate layers.